# 506147572 07/10/2020

# PATENT ASSIGNMENT COVER SHEET

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

#### **CONVEYING PARTY DATA**

Name	Execution Date
TIFFANY DORIA	06/08/2020
RICHARD NEVILLE HIBBS	06/04/2020
TIONG KHAI SOO	06/04/2020
ERNEST M. THURLOW	06/03/2020
ZIDONG LIN	06/05/2020
ROBERT MORRIS WILCOX	06/10/2020

## **RECEIVING PARTY DATA**

Name:	ARISTA NETWORKS, INC.
Street Address:	5453 GREAT AMERICA PARKWAY
City:	SANTA CLARA
State/Country:	CALIFORNIA
Postal Code:	95054

#### **PROPERTY NUMBERS Total: 1**

Property Type	Number
Application Number:	16896637

### **CORRESPONDENCE DATA**

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ATTORNEY DOCKET NUMBER:	170383-016400US
NAME OF SUBMITTER:	ALY Z. DOSSA
SIGNATURE:	/Aly Z. Dossa/
DATE SIGNED:	07/09/2020
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**Total Attachments: 4** 

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## ASSIGNMENT - WORLDWIDE

For good and valuable consideration, the receipt and sufficiency of which are hereby acknowledged, the undersigned individual(s) (referred to herein as the "INVENTOR(S)") hereby assign, transfer, and set over to:

Arista Networks, Inc.

having the following address:

5453 Great America Parkway Santa Clara, CA 95054

(referred to herein as "COMPANY"), its successors, and assigns, the entire right, title, and interest, worldwide, in and to the invention known by the following title:

### SYSTEMS FOR PROVIDING THERMAL MANAGEMENT TO INTEGRATED CIRCUITS

for which the INVENTOR(S) or COMPANY has/have made an application for patent in the United States of America, together with said patent application, all divisions, continuations, continuations-in-part, reissues, and extensions thereof, and all Letters Patent (domestic and foreign) which may be granted therefor. Such interest represents the entire ownership of said applications and Letters Patent when granted and is to be owned by COMPANY, its successors, and assigns, or their legal representatives, for the full and entire term for which such Letters Patent may be granted or extended, as fully and entirely as the same would have been enjoyed by the INVENTOR(S) if this assignment had not been made.

In addition, the undersigned INVENTOR(S) each hereby agrees:

- To sign and execute any further documents which may be necessary or desirable, lawful, and proper in connection with the prosecution of all applications for patent(s) on the INVENTION in the United States, including without limitation said application and all divisions, continuations, continuations-in-part, amendments thereof, and all interference proceedings associated therewith, or otherwise necessary or desirable to secure the title thereto to COMPANY;
- To execute all papers and documents and to perform all lawful acts which may be necessary in connection with claims to priority or otherwise under the International Convention for the Protection of Industrial Property or similar treaties or agreements;
- 3. To perform all lawful affirmative acts which may be necessary to obtain the grant of a valid and enforceable patent to COMPANY.

The undersigned INVENTOR(S) each hereby authorizes and requests the Commissioner of Patents and Trademarks in the United States to issue any and all Letters Patent resulting from said application, including without limitation any division, continuation, continuation-in-part, or reissue thereof to COMPANY.

The undersigned INVENTOR(S) each hereby grants to the firm of CHAMBERLAIN, HRDLICKA, WHITE, WILLIAMS & AUGHTRY, P.C. the power to insert on this Assignment any further identification which may be necessary or desirable in order to comply with the rules of the United States Patent and Trademark Office for the recordation of this document.

IN WITNESS WHEREOF, this Assignment has been executed by each of the undersigned individuals on the date appearing by such individual's signature:

6/8/2020	1st Inventor Signature:	/Tiffany Doria /
Date	Print or Type Name:	Tiffany Doria
6/4/2020	2 <sup>nd</sup> Inventor Signature:	//
Date	Print or Type Name:	Robert Morris Wilcox
6/4/2020	3 <sup>rd</sup> Inventor Signature:	/Richard Neville Hibbs /
Date	Print or Type Name:	Richard Neville Hibbs
6/4/2020	4 <sup>th</sup> Inventor Signature:	/Tiong Khai Soo /
Date	Print or Type Name:	Tiong Khai Soo
6/3/2020	5 <sup>th</sup> Inventor Signature:	/Ernest Thurlow/
Date	Print or Type Name:	Ernest M. Thurlow
6/5/2020	6 <sup>th</sup> Inventor Signature:	/Zidong Lin/
Date	Print or Type Name:	Zidong Lin

When this Assignment is <u>not</u> filed concurrently with the patent application, the following identifying information may be added <u>after</u> execution:

U.S. Application Serial No.: 16/896,637 Filing Date: June 9, 2020

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For good and valuable consideration, the receipt and sufficiency of which are hereby acknowledged, the undersigned individual(s) (referred to herein as the "INVENTOR(S)") hereby assign, transfer, and set over to:

Arista Networks, Inc.

having the following address:

5453 Great America Parkway Santa Clara, CA 95054

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- To sign and execute any further documents which may be necessary or desirable, lawful, and proper in connection with the prosecution of all applications for patent(s) on the INVENTION in the United States, including without limitation said application and all divisions, continuations, continuations-in-part, amendments thereof, and all interference proceedings associated therewith, or otherwise necessary or desirable to secure the title thereto to COMPANY;
- To execute all papers and documents and to perform all lawful acts which may be necessary in connection with claims to priority or otherwise under the International Convention for the Protection of Industrial Property or similar treaties or agreements;
- 3. To perform all lawful affirmative acts which may be necessary to obtain the grant of a valid and enforceable patent to COMPANY.

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IN WITNESS WHEREOF, this Assignment has been executed by each of the undersigned individuals on the date appearing by such individual's signature:

	1st Inventor Signature:	
Date	Print or Type Name:	Tiffany Doria
6/10/2020	2 <sup>nd</sup> Inventor Signature:	/Robert Morris Wilcox/
Date	Print or Type Name:	Robert Morris Wilcox
	3rd Inventor Signature:	
Date	Print or Type Name:	Richard Neville Hibbs
	4 <sup>th</sup> Inventor Signature:	
Date	Print or Type Name:	Tiong Khai Soo
	5th Inventor Signature:	
Date	Print or Type Name:	Ernest M. Thurlow
	6th Inventor Signature:	
Date	Print or Type Name:	Zidong Lin

When this Assignment is <u>not</u> filed concurrently with the patent application, the following identifying information may be added <u>after</u> execution:

U.S. Application Serial No.: 16/896,637 Filing Date: June 9, 2020

> PATENT REEL: 053173 FRAME: 0128

**RECORDED: 07/10/2020**